

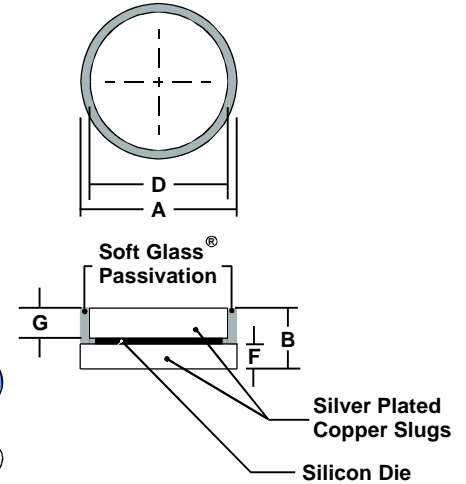
25 AMP SOZA DIODE CELLS

FEATURES

- PROPRIETARY **SOFT GLASS[®]** JUNCTION PASSIVATION FOR SUPERIOR RELIABILITY AND PERFORMANCE
- VOID FREE VACUUM DIE SOLDERING FOR MAXIMUM MECHANICAL STRENGTH AND HEAT DISSIPATION (Solder Voids: Typical < 2%, Max. < 10% of Die Area)
- Large die for high power capability
- Very low forward voltage drop
- Built-in stress relief mechanism for die protection
- Silver plated substrates for easy soldering or installation
- Soldering temperature: 250 °C maximum
- Protects expensive automotive electronics and mobile equipment

SOFT GLASS[®] DIODE

Die Size:
0.180"
Round



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.36	5.56	0.211	0.219
B	1.98	2.18	0.078	0.086
D	4.72	4.93	0.186	0.194
F	0.76 Typ		0.030 Typ	
G	1.02 Typ		0.040 Typ	

MAXIMUM RATINGS & ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified.

PARAMETER (TEST CONDITIONS)	SYMBOL	RATINGS							UNITS
		BAR 2500D	BAR 2501D	BAR 2502D	BAR 2504D	BAR 2506D	BAR 2508D	BAR 2510D	
Series Number									
Maximum Recurrent Peak Reverse Voltage	VRRM								VOLTS
Working Peak Reverse Voltage	VRWM	50	100	200	400	600	800	1000	
Maximum DC Blocking Voltage	VDC								
Non-repetitive Peak Reverse Voltage (Half wave, Single phase, 60Hz peak)	VRSM	60	120	240	480	720	960	1200	AMPS
Average Rectified Forward Current (Single phase, Resistive load, 60Hz)	I _o	25							
Non-repetitive Peak Forward Surge Current (Half wave, Single phase, 60Hz sine applied to rated load)	I _{FSM}	500							
Maximum Instantaneous Forward Voltage @ I _F = 6 Amps @ I _F = 25 Amps	V _F	0.85			0.90				VOLTS
		1.05			1.10				
Maximum DC Reverse Current At Rated DC Blocking Voltage @ T _c = 25 °C	I _R	0.5							μA
Operating & Storage Temperature Range	T _J , T _{STG}	-65 to +175							°C

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